



SGX RELEASE

Temasek redeems US\$1.2 billion 2.375% Temasek Bond due 2023

Singapore, 23 January 2023 – Temasek Holdings (Private) Limited (“Temasek”) has redeemed its US\$1.2 billion 2.375% Guaranteed Notes due 2023 (“T2023-USD Temasek Bond”), issued through its wholly-owned subsidiary, Temasek Financial (I) Limited (“TFin-I”).

The T2023-USD Temasek Bond had an issue size of US\$1.2 billion and a coupon of 2.375% per annum.

The T2023-USD Temasek Bond was issued 10.5 years ago in July 2012 by TFin-I under Temasek’s US\$10 billion Guaranteed Global Medium Term Note (MTN) Program, and guaranteed by Temasek. Temasek’s US\$10 billion Guaranteed Global MTN Program size was increased to US\$15 billion in July 2013, then to US\$20 billion in July 2018 and then to US\$25 billion in September 2020.

On its maturity date of 23 January 2023, the T2023-USD Temasek Bond was redeemed at par and cancelled in accordance with its terms.

With the redemption of the T2023-USD Temasek Bond, Temasek has 21 series of outstanding Temasek Bonds.

Temasek would like to thank investors for their confidence and support in its T2023-USD Temasek Bond.

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References to “US\$” and “USD” refer to the United States dollars, the lawful currency of the United States.

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